

# 74LVC1G17

Single Schmitt trigger buffer

Rev. 06 — 27 August 2007

Product data sheet

## 1. General description

The 74LVC1G17 provides a buffer function with Schmitt trigger action. It is capable of transforming slowly changing input signals into sharply defined outputs.

The input can be driven from either 3.3 V or 5 V devices. This feature allows the use of this device in a mixed 3.3 V and 5 V environment.

This device is fully specified for partial power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

## 2. Features

- Wide supply voltage range from 1.65 V to 5.5 V
- High noise immunity
- Complies with JEDEC standard
  - ◆ JESD8-7 (1.65 V to 1.95 V)
  - ◆ JESD8-5 (2.3 V to 2.7 V)
  - ◆ JESD8B/JESD36 (2.7 V to 3.6 V)
- $\pm 24$  mA output drive ( $V_{CC} = 3.0$  V)
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Unlimited rise and fall times
- Inputs accept voltages up to 5 V
- Multiple package options
- ESD protection:
  - ◆ HBM JESD22-A114E exceeds 2000 V
  - ◆ MM JESD22-A115-A exceeds 200 V
- Specified from  $-40$  °C to  $+125$  °C

### 3. Ordering information

Table 1. Ordering information

| Type number | Package           |        |   |          |
|-------------|-------------------|--------|---|----------|
|             | Temperature range | Name   | Description   | Version  |
| 74LVC1G17GW | −40 °C to +125 °C | TSSOP5 | plastic thin shrink small outline package; 5 leads; body width 1.25 mm                      | SOT353-1 |
| 74LVC1G17GV | −40 °C to +125 °C | SC-74A | plastic surface-mounted package; 5 leads  | SOT753   |
| 74LVC1G17GM | −40 °C to +125 °C | XSON6  | plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1.45 × 0.5 mm | SOT886   |
| 74LVC1G17GF | −40 °C to +125 °C | XSON6  | plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1 × 0.5 mm    | SOT891   |

### 4. Marking

Table 2. Marking codes

| Type number | Marking |
|-------------|---------|
| 74LVC1G17GW | VJ      |
| 74LVC1G17GV | V17     |
| 74LVC1G17GM | VJ      |
| 74LVC1G17GF | VJ      |

### 5. Functional diagram

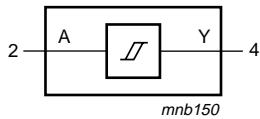


Fig 1. Logic symbol

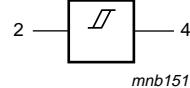


Fig 2. IEC logic symbol

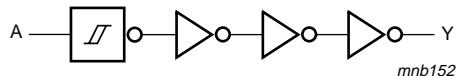
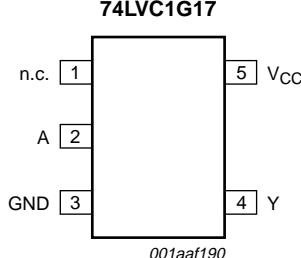
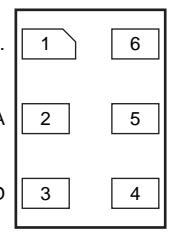
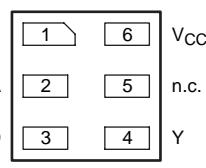


Fig 3. Logic diagram

## 6. Pinning information

### 6.1 Pinning

|   |   |   |
|---|---|---|
|  <p><b>74LVC1G17</b></p> <p>n.c. 1<br/>A 2<br/>GND 3<br/>Y 4<br/>VCC 5</p> <p>001aaaf190</p> |  <p><b>74LVC1G17</b></p> <p>n.c. 1 6<br/>A 2 5<br/>GND 3 4<br/>Y n.c.<br/>VCC n.c.</p> <p>001aaaf191</p> <p>Transparent top view</p> |  <p><b>74LVC1G17</b></p> <p>n.c. 1 6<br/>A 2 5<br/>GND 3 4<br/>Y n.c.<br/>VCC n.c.</p> <p>001aaaf402</p> <p>Transparent top view</p> |
| <b>Fig 4. Pin configuration SOT353-1 and SOT753</b>   | <b>Fig 5. Pin configuration SOT886</b>  | <b>Fig 6. Pin configuration SOT891</b>  |

### 6.2 Pin description

**Table 3. Pin description**

| Symbol          | Pin             |               | Description    |
|-----------------|-----------------|---------------|----------------|
|                 | SOT353-1/SOT753 | SOT886/SOT891 |                |
| n.c.            | 1               | 1, 5          | not connected  |
| A               | 2               | 2             | data input     |
| GND             | 3               | 3             | ground (0 V)   |
| Y               | 4               | 4             | data output    |
| V <sub>CC</sub> | 5               | 6             | supply voltage |

## 7. Functional description

**Table 4. Function table<sup>[1]</sup>**

| Input | Output |
|-------|--------|
| A     | Y      |
| L     | L      |
| H     | H      |

[1] H = HIGH voltage level; L = LOW voltage level

## 8. Limiting values

**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter               | Conditions   | Min    | Max  | Unit                  |    |
|------------------|-------------------------|--|--------|------|-----------------------|----|
| V <sub>CC</sub>  | supply voltage          |  | -0.5   | +6.5 | V                     |    |
| I <sub>IK</sub>  | input clamping current  | V <sub>I</sub> < 0 V                                     | -50    | -    | mA                    |    |
| V <sub>I</sub>   | input voltage           |  | [1]    | -0.5 | +6.5                  | V  |
| I <sub>OK</sub>  | output clamping current | V <sub>O</sub> > V <sub>CC</sub> or V <sub>O</sub> < 0 V | -      | ±50  | mA                    |    |
| V <sub>O</sub>   | output voltage          | Active mode  | [1][2] | -0.5 | V <sub>CC</sub> + 0.5 | V  |
|                  |                         | Power-down mode  | [1][2] | -0.5 | +6.5                  | V  |
| I <sub>O</sub>   | output current          | V <sub>O</sub> = 0 V to V <sub>CC</sub>                  | -      | ±50  | mA                    |    |
| I <sub>CC</sub>  | supply current          |  | -      | 100  | mA                    |    |
| I <sub>GND</sub> | ground current          |  | -100   | -    | mA                    |    |
| P <sub>tot</sub> | total power dissipation | T <sub>amb</sub> = -40 °C to +125 °C                     | [3]    | -    | 250                   | mW |
| T <sub>stg</sub> | storage temperature     |  | -65    | +150 | °C                    |    |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] When V<sub>CC</sub> = 0 V (Power-down mode), the output voltage can be 5.5 V in normal operation.

[3] For TSSOP5 and SC-74A packages: above 87.5 °C the value of P<sub>tot</sub> derates linearly with 4.0 mW/K.

For XSON6 packages: above 45 °C the value of P<sub>tot</sub> derates linearly with 2.4 mW/K.

## 9. Recommended operating conditions

**Table 6. Recommended operating conditions**

| Symbol           | Parameter           | Conditions                             | Min  | Typ | Max             | Unit |
|------------------|---------------------|--|------|-----|-----------------|------|
| V <sub>CC</sub>  | supply voltage      |  | 1.65 | -   | 5.5             | V    |
| V <sub>I</sub>   | input voltage       |  | 0    | -   | 5.5             | V    |
| V <sub>O</sub>   | output voltage      | Active mode                            | 0    | -   | V <sub>CC</sub> | V    |
|                  |                     | V <sub>CC</sub> = 0 V; Power-down mode | 0    | -   | 5.5             | V    |
| T <sub>amb</sub> | ambient temperature |  | -40  | -   | +125            | °C   |

## 10. Static characteristics

**Table 7. Static characteristics**

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol                                    | Parameter                 | Conditions  | Min                   | Typ <sup>[1]</sup> | Max | Unit |
|---|---------------------------|---|-----------------------|--------------------|-----|------|
| <b>T<sub>amb</sub> = -40 °C to +85 °C</b> |                           |   |                       |                    |     |      |
| V <sub>OH</sub>                           | HIGH-level output voltage | V <sub>I</sub> = V <sub>CC</sub> or GND                     |                       |                    |     |      |
|   |                           | I <sub>O</sub> = -100 µA; V <sub>CC</sub> = 1.65 V to 5.5 V | V <sub>CC</sub> - 0.1 | -                  | -   | V    |
|   |                           | I <sub>O</sub> = -4 mA; V <sub>CC</sub> = 1.65 V            | 1.2                   | -                  | -   | V    |
|   |                           | I <sub>O</sub> = -8 mA; V <sub>CC</sub> = 2.3 V             | 1.9                   | -                  | -   | V    |
|   |                           | I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 2.7 V            | 2.2                   | -                  | -   | V    |
|   |                           | I <sub>O</sub> = -24 mA; V <sub>CC</sub> = 3.0 V            | 2.3                   | -                  | -   | V    |
|   |                           | I <sub>O</sub> = -32 mA; V <sub>CC</sub> = 4.5 V            | 3.8                   | -                  | -   | V    |

**Table 7. Static characteristics ...continued**

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol                                     | Parameter                 | Conditions   | Min                   | Typ <sup>[1]</sup> | Max  | Unit |
|--|---------------------------|--|-----------------------|--------------------|------|------|
| V <sub>OL</sub>                            | LOW-level output voltage  | V <sub>I</sub> = V <sub>CC</sub> or GND  |                       |                    |      |      |
|  |                           | I <sub>O</sub> = 100 µA; V <sub>CC</sub> = 1.65 V to 5.5 V   | -                     | -                  | 0.1  | V    |
|  |                           | I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 1.65 V  | -                     | -                  | 0.45 | V    |
|  |                           | I <sub>O</sub> = 8 mA; V <sub>CC</sub> = 2.3 V   | -                     | -                  | 0.3  | V    |
|  |                           | I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V  | -                     | -                  | 0.4  | V    |
|  |                           | I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V  | -                     | -                  | 0.55 | V    |
|  |                           | I <sub>O</sub> = 32 mA; V <sub>CC</sub> = 4.5 V  | -                     | -                  | 0.55 | V    |
| I <sub>I</sub>                             | input leakage current     | V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V  | -                     | ±0.1               | ±5   | µA   |
| I <sub>OFF</sub>                           | power-off leakage current | V <sub>I</sub> or V <sub>O</sub> = 5.5 V; V <sub>CC</sub> = 0 V  | -                     | ±0.1               | ±10  | µA   |
| I <sub>CC</sub>                            | supply current            | V <sub>I</sub> = 5.5 V or GND;<br>V <sub>CC</sub> = 1.65 V to 5.5 V; I <sub>O</sub> = 0 A                    | -                     | 0.1                | 10   | µA   |
| ΔI <sub>CC</sub>                           | additional supply current | V <sub>I</sub> = V <sub>CC</sub> – 0.6 V; I <sub>O</sub> = 0 A;<br>V <sub>CC</sub> = 2.3 V to 5.5 V; per pin | -                     | 5                  | 500  | µA   |
| C <sub>I</sub>                             | input capacitance         |  | -                     | 5                  | -    | pF   |
| <b>T<sub>amb</sub> = -40 °C to +125 °C</b> |                           |  |                       |                    |      |      |
| V <sub>OH</sub>                            | HIGH-level output voltage | V <sub>I</sub> = V <sub>CC</sub> or GND  |                       |                    |      |      |
|  |                           | I <sub>O</sub> = -100 µA; V <sub>CC</sub> = 1.65 V to 5.5 V  | V <sub>CC</sub> – 0.1 | -                  | -    | V    |
|  |                           | I <sub>O</sub> = -4 mA; V <sub>CC</sub> = 1.65 V   | 0.95                  | -                  | -    | V    |
|  |                           | I <sub>O</sub> = -8 mA; V <sub>CC</sub> = 2.3 V  | 1.7                   | -                  | -    | V    |
|  |                           | I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 2.7 V   | 1.9                   | -                  | -    | V    |
|  |                           | I <sub>O</sub> = -24 mA; V <sub>CC</sub> = 3.0 V   | 2.0                   | -                  | -    | V    |
|  |                           | I <sub>O</sub> = -32 mA; V <sub>CC</sub> = 4.5 V   | 3.4                   | -                  | -    | V    |
| V <sub>OL</sub>                            | LOW-level output voltage  | V <sub>I</sub> = V <sub>CC</sub> or GND  |                       |                    |      |      |
|  |                           | I <sub>O</sub> = 100 µA; V <sub>CC</sub> = 1.65 V to 5.5 V   | -                     | -                  | 0.1  | V    |
|  |                           | I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 1.65 V  | -                     | -                  | 0.7  | V    |
|  |                           | I <sub>O</sub> = 8 mA; V <sub>CC</sub> = 2.3 V   | -                     | -                  | 0.45 | V    |
|  |                           | I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V  | -                     | -                  | 0.6  | V    |
|  |                           | I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V  | -                     | -                  | 0.80 | V    |
|  |                           | I <sub>O</sub> = 32 mA; V <sub>CC</sub> = 4.5 V  | -                     | -                  | 0.80 | V    |
| I <sub>I</sub>                             | input leakage current     | V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V  | -                     | -                  | ±100 | µA   |
| I <sub>OFF</sub>                           | power-off leakage current | V <sub>I</sub> or V <sub>O</sub> = 5.5 V; V <sub>CC</sub> = 0 V  | -                     | -                  | ±200 | µA   |
| I <sub>CC</sub>                            | supply current            | V <sub>I</sub> = 5.5 V or GND;<br>V <sub>CC</sub> = 1.65 V to 5.5 V; I <sub>O</sub> = 0 A                    | -                     | -                  | 200  | µA   |
| ΔI <sub>CC</sub>                           | additional supply current | per pin; V <sub>I</sub> = V <sub>CC</sub> – 0.6 V; I <sub>O</sub> = 0 A;<br>V <sub>CC</sub> = 2.3 V to 5.5 V | -                     | -                  | 5000 | µA   |

[1] All typical values are measured at maximum V<sub>CC</sub> and T<sub>amb</sub> = 25 °C.

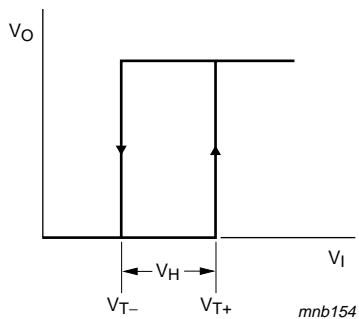
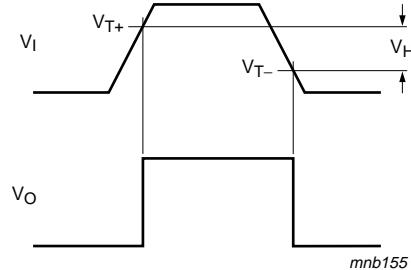
**Table 8. Transfer characteristics**

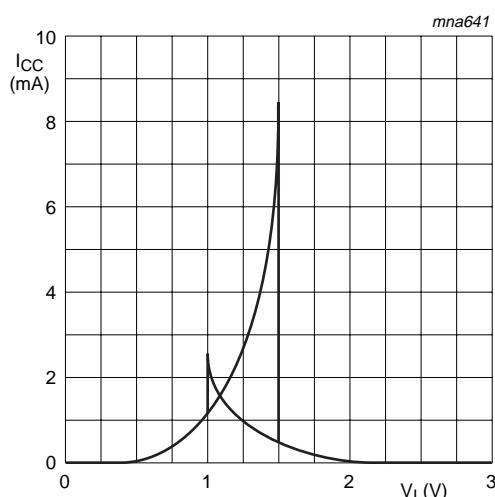
At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol          | Parameter  | Conditions              | −40 °C to +85 °C |                    |      | −40 °C to +125 °C |      | Unit |
|-----------------|--|-------------------------|------------------|--------------------|------|-------------------|------|------|
|                 |  |                         | Min              | Typ <sup>[1]</sup> | Max  | Min               | Max  |      |
| V <sub>T+</sub> | positive-going threshold voltage<br>see <a href="#">Figure 7</a> and <a href="#">Figure 8</a>              | V <sub>CC</sub> = 1.8 V | 0.82             | 1.0                | 1.14 | 0.79              | 1.14 | V    |
|                 |  | V <sub>CC</sub> = 2.3 V | 1.03             | 1.2                | 1.40 | 1.00              | 1.40 | V    |
|                 |  | V <sub>CC</sub> = 3.0 V | 1.29             | 1.5                | 1.71 | 1.26              | 1.71 | V    |
|                 |  | V <sub>CC</sub> = 4.5 V | 1.84             | 2.1                | 2.36 | 1.81              | 2.36 | V    |
|                 |  | V <sub>CC</sub> = 5.5 V | 2.19             | 2.5                | 2.79 | 2.16              | 2.79 | V    |
| V <sub>T−</sub> | negative-going threshold voltage<br>see <a href="#">Figure 7</a> and <a href="#">Figure 8</a>              | V <sub>CC</sub> = 1.8 V | 0.46             | 0.6                | 0.75 | 0.46              | 0.78 | V    |
|                 |  | V <sub>CC</sub> = 2.3 V | 0.65             | 0.8                | 0.96 | 0.65              | 0.99 | V    |
|                 |  | V <sub>CC</sub> = 3.0 V | 0.88             | 1.0                | 1.24 | 0.88              | 1.27 | V    |
|                 |  | V <sub>CC</sub> = 4.5 V | 1.32             | 1.5                | 1.84 | 1.32              | 1.87 | V    |
|                 |  | V <sub>CC</sub> = 5.5 V | 1.58             | 1.8                | 2.24 | 1.58              | 2.27 | V    |
| V <sub>H</sub>  | hysteresis voltage<br>see <a href="#">Figure 7</a> , <a href="#">Figure 8</a> and <a href="#">Figure 9</a> | V <sub>CC</sub> = 1.8 V | 0.26             | 0.4                | 0.51 | 0.19              | 0.51 | V    |
|                 |  | V <sub>CC</sub> = 2.3 V | 0.28             | 0.4                | 0.57 | 0.22              | 0.57 | V    |
|                 |  | V <sub>CC</sub> = 3.0 V | 0.31             | 0.5                | 0.64 | 0.25              | 0.64 | V    |
|                 |  | V <sub>CC</sub> = 4.5 V | 0.40             | 0.6                | 0.77 | 0.34              | 0.77 | V    |
|                 |  | V <sub>CC</sub> = 5.5 V | 0.47             | 0.6                | 0.88 | 0.41              | 0.88 | V    |

[1] All typical values are measured at T<sub>amb</sub> = 25 °C.

## 10.1 Transfer characteristic waveforms

**Fig 7. Transfer characteristic****Fig 8. Definitions of  $V_{T+}$ ,  $V_{T-}$  and  $V_H$**



$V_{CC} = 3.0 \text{ V}$

Fig 9. Typical transfer characteristics

## 11. Dynamic characteristics

Table 9. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see [Figure 11](#).

| Symbol   | Parameter  | Conditions   | -40 °C to +85 °C |                    |      | -40 °C to +125 °C |      | Unit |
|----------|--|--|------------------|--------------------|------|-------------------|------|------|
|          |  |  | Min              | Typ <sup>[1]</sup> | Max  | Min               | Max  |      |
| $t_{pd}$ | propagation delay<br>A to Y; see <a href="#">Figure 10</a> | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$<br>$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$<br>$V_{CC} = 2.7 \text{ V}$<br>$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$<br>$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | [2]              |                    |      |                   |      |      |
|          |  |  | 1.0              | 4.1                | 11.0 | 1.0               | 14.0 | ns   |
|          |  |  | 0.7              | 2.8                | 6.5  | 0.7               | 8.5  | ns   |
|          |  |  | 0.7              | 3.2                | 6.5  | 0.7               | 8.5  | ns   |
|          |  |  | 0.7              | 3.0                | 5.5  | 0.7               | 7.0  | ns   |
| $C_{PD}$ | power dissipation capacitance                              | $V_I = \text{GND to } V_{CC};$<br>$V_{CC} = 3.3 \text{ V}$   | [3]              | -                  | 16.6 | -                 | -    | pF   |

[1] Typical values are measured at  $T_{amb} = 25 \text{ °C}$  and  $V_{CC} = 1.8 \text{ V}, 2.5 \text{ V}, 2.7 \text{ V}, 3.3 \text{ V}$  and  $5.0 \text{ V}$  respectively.

[2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

[3]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu\text{W}$ ).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

$f_i$  = input frequency in MHz;

$f_o$  = output frequency in MHz;

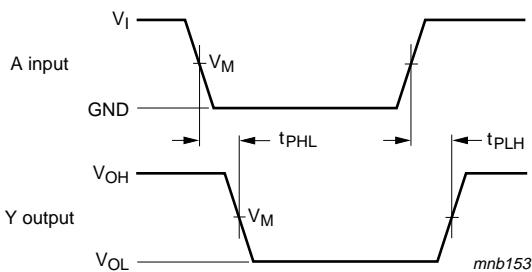
$C_L$  = output load capacitance in pF;

$V_{CC}$  = supply voltage in V;

N = number of inputs switching;

$\sum(C_L \times V_{CC}^2 \times f_o)$  = sum of outputs.

## 12. Waveforms



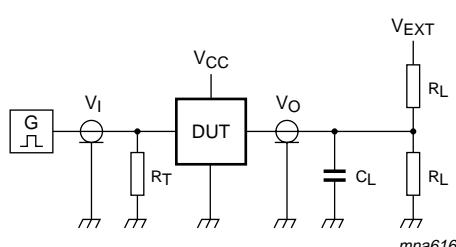
Measurement points are given in [Table 10](#).

$V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

**Fig 10. The input A to output Y propagation delay times**

**Table 10. Measurement points**

| Supply voltage   | Input               | Output              |
|------------------|---------------------|---------------------|
| $V_{CC}$         | $V_M$               | $V_M$               |
| 1.65 V to 1.95 V | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ |
| 2.3 V to 2.7 V   | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ |
| 2.7 V            | 1.5 V               | 1.5 V               |
| 3.0 V to 3.6 V   | 1.5 V               | 1.5 V               |
| 4.5 V to 5.5 V   | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ |



Test data is given in [Table 11](#).

Definitions for test circuit:

$R_L$  = Load resistance.

$C_L$  = Load capacitance including jig and probe capacitance.

$R_T$  = Termination resistance should be equal to the output impedance  $Z_o$  of the pulse generator.

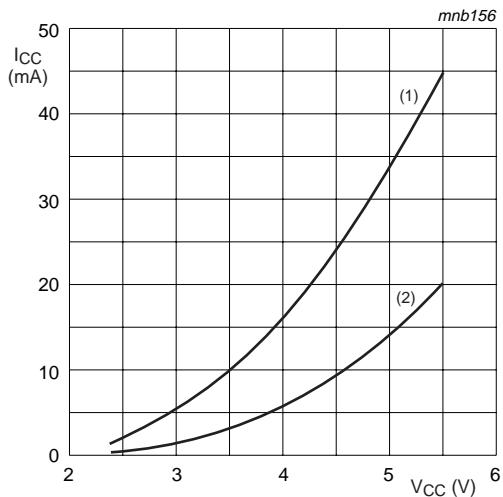
$V_{EXT}$  = External voltage for measuring switching times.

**Fig 11. Load circuitry for switching times**

**Table 11. Test data**

| Supply voltage   | Input           |                                 | Load           |                | V <sub>EXT</sub>                    |
|------------------|-----------------|---------------------------------|----------------|----------------|-------------------------------------|
| V <sub>CC</sub>  | V <sub>I</sub>  | t <sub>r</sub> = t <sub>f</sub> | C <sub>L</sub> | R <sub>L</sub> | t <sub>PLH</sub> , t <sub>PHL</sub> |
| 1.65 V to 1.95 V | V <sub>CC</sub> | ≤ 2.0 ns                        | 30 pF          | 1 kΩ           | open                                |
| 2.3 V to 2.7 V   | V <sub>CC</sub> | ≤ 2.0 ns                        | 30 pF          | 500 Ω          | open                                |
| 2.7 V            | 2.7 V           | ≤ 2.5 ns                        | 50 pF          | 500 Ω          | open                                |
| 3.0 V to 3.6 V   | 2.7 V           | ≤ 2.5 ns                        | 50 pF          | 500 Ω          | open                                |
| 4.5 V to 5.5 V   | V <sub>CC</sub> | ≤ 2.5 ns                        | 50 pF          | 500 Ω          | open                                |

## 13. Application information



Linear change of V<sub>I</sub> between 0.8 V to 2.0 V.

- (1) Positive-going edge.
- (2) Negative-going edge.

**Fig 12. Average supply current as a function of supply voltage**

## 14. Package outline

TSSOP5: plastic thin shrink small outline package; 5 leads; body width 1.25 mm

SOT353-1

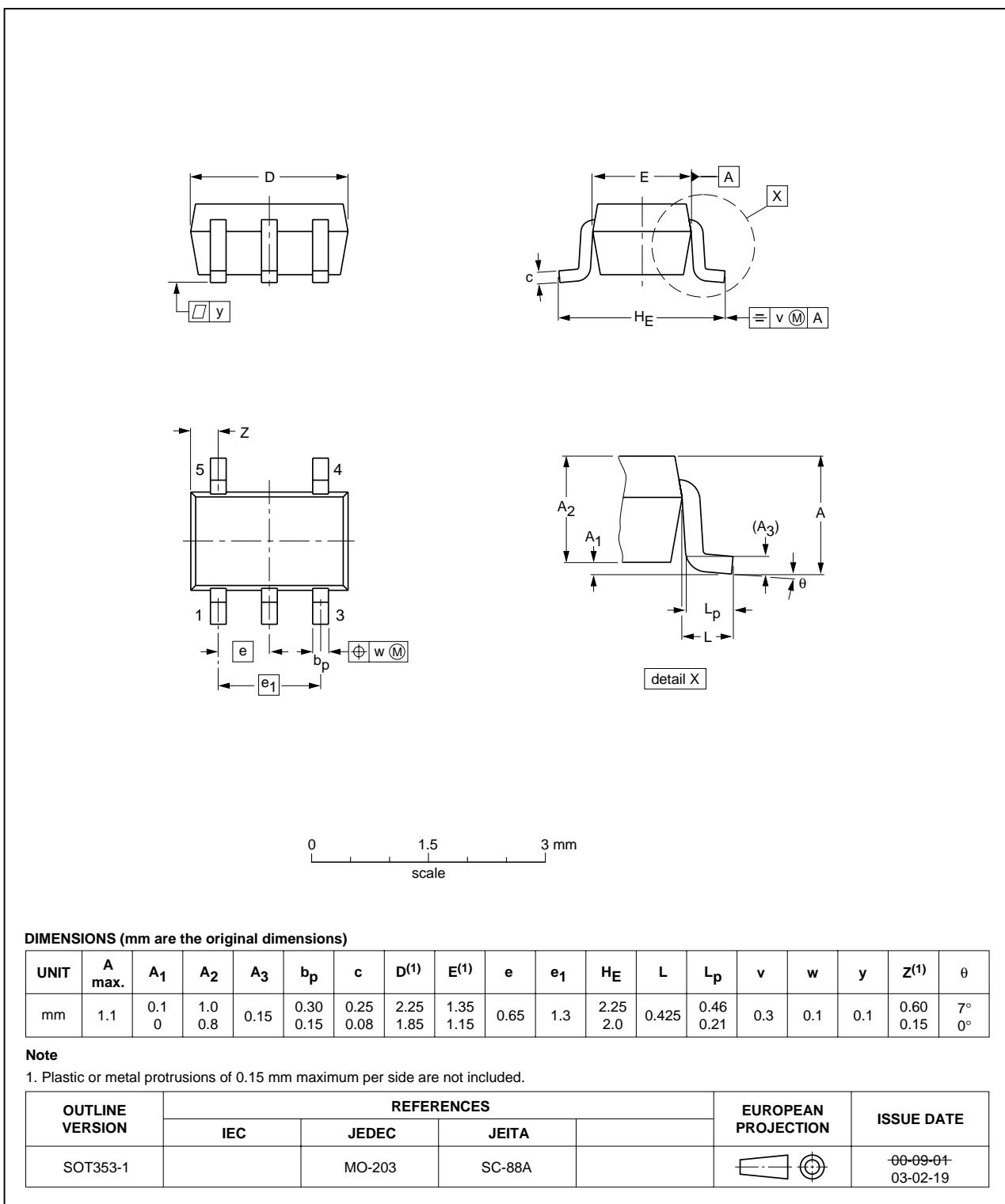


Fig 13. Package outline SOT353-1 (TSSOP5)

## Plastic surface-mounted package; 5 leads

SOT753

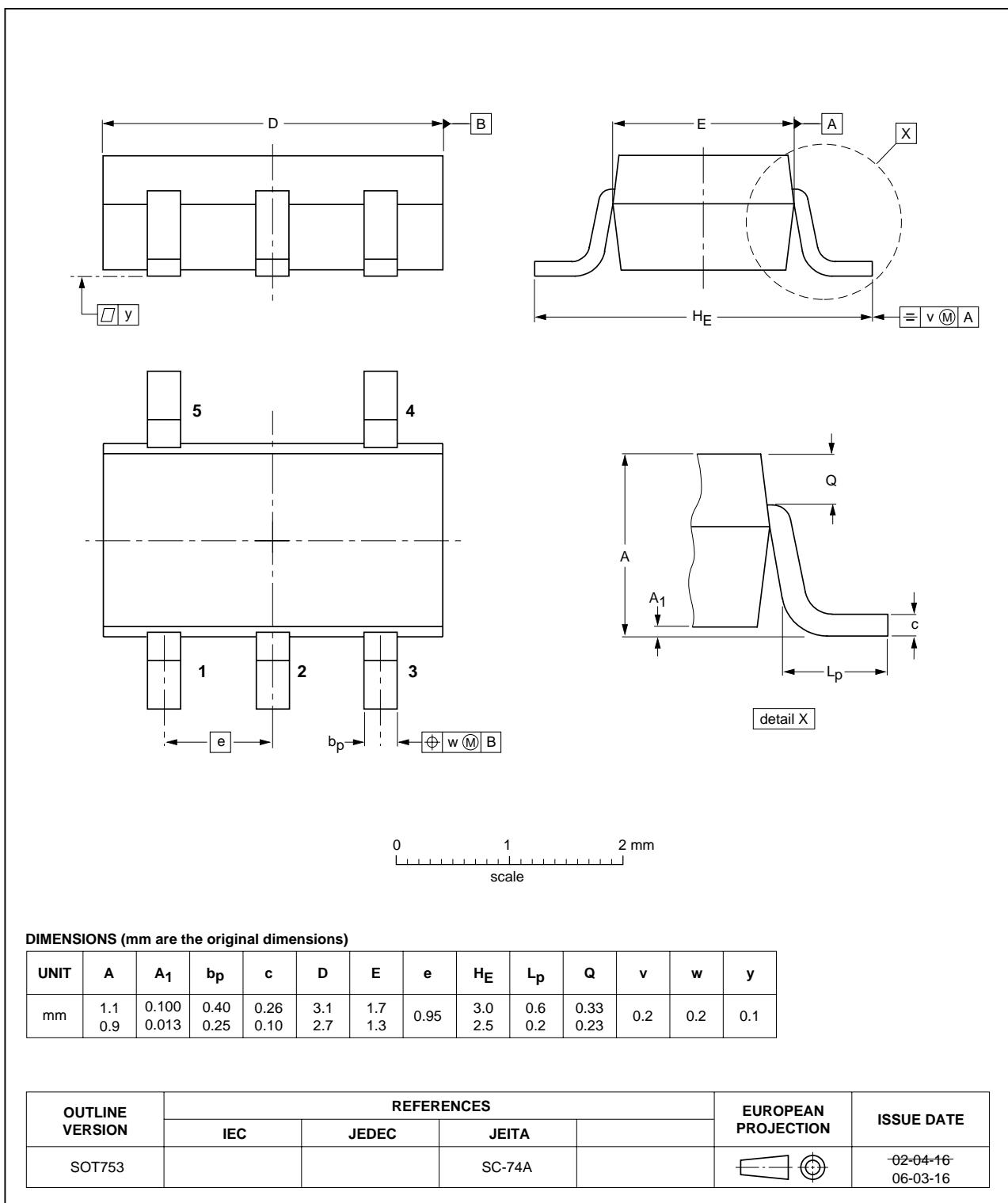
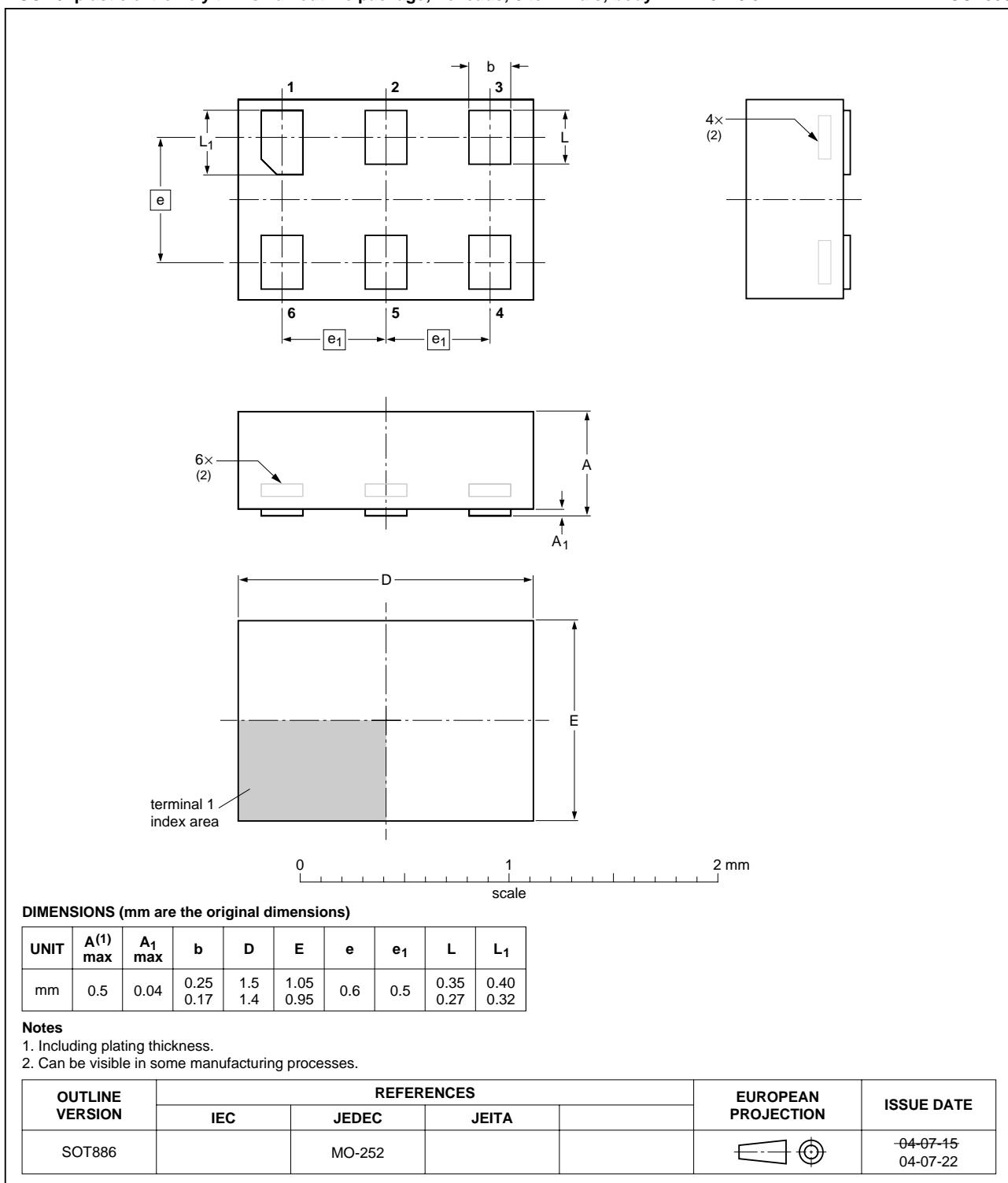


Fig 14. Package outline SOT753 (SC-74A)

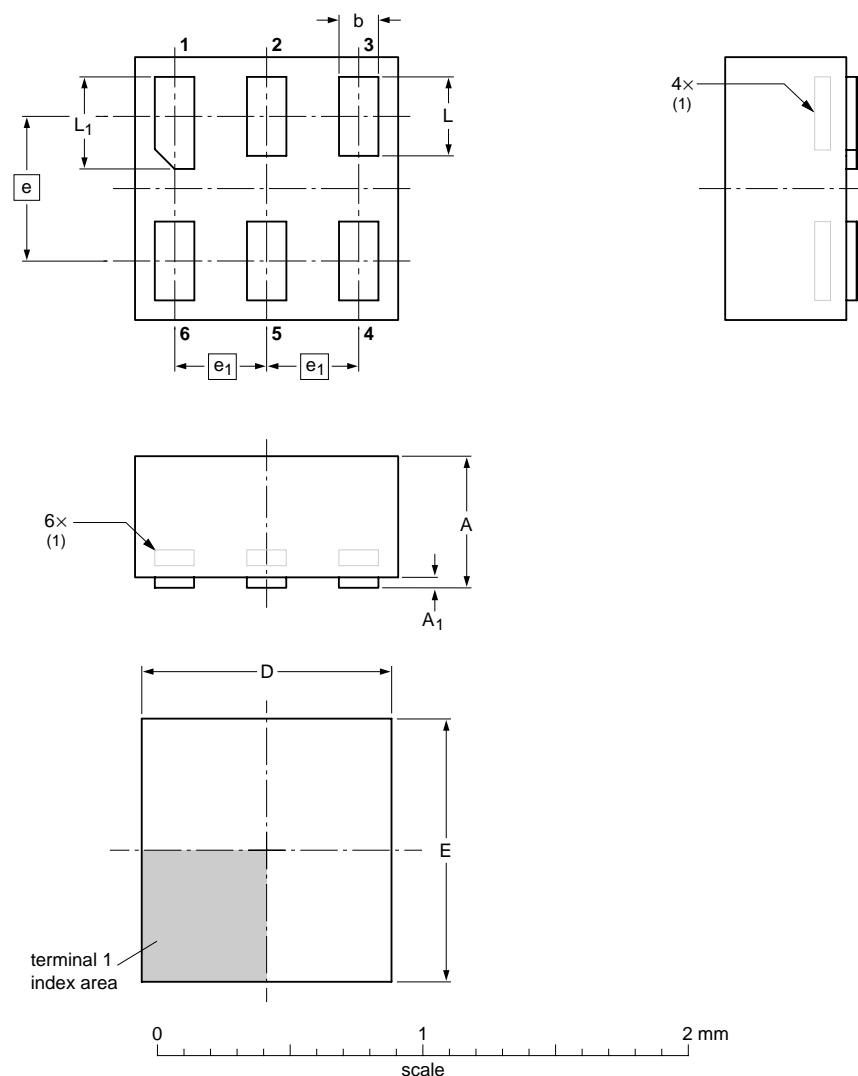
XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1.45 x 0.5 mm

SOT886

**Fig 15. Package outline SOT886 (XSON6)**

XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1 x 0.5 mm

SOT891

**DIMENSIONS (mm are the original dimensions)**

| UNIT | A<br>max | A <sub>1</sub><br>max | b            | D            | E            | e    | e <sub>1</sub> | L            | L <sub>1</sub> |
|------|----------|-----------------------|--------------|--------------|--------------|------|----------------|--------------|----------------|
| mm   | 0.5      | 0.04                  | 0.20<br>0.12 | 1.05<br>0.95 | 1.05<br>0.95 | 0.55 | 0.35<br>0.27   | 0.35<br>0.27 | 0.40<br>0.32   |

**Note**

1. Can be visible in some manufacturing processes.

| OUTLINE<br>VERSION | REFERENCES |       |       |  | EUROPEAN<br>PROJECTION | ISSUE DATE            |
|--------------------|------------|-------|-------|--|------------------------|-----------------------|
|                    | IEC        | JEDEC | JEITA |  |                        |                       |
| SOT891             |            |       |       |  |                        | -05-04-06<br>07-05-15 |

**Fig 16. Package outline SOT891 (XSON6)**

## 15. Abbreviations

**Table 12. Abbreviations**

| Acronym | Description                             |
|---------|---|
| CMOS    | Complementary Metal Oxide Semiconductor |
| DUT     | Device Under Test                       |
| ESD     | ElectroStatic Discharge                 |
| HBM     | Human Body Model                        |
| MM      | Machine Model                           |
| TTL     | Transistor-Transistor Logic             |

## 16. Revision history

**Table 13. Revision history**

| Document ID    | Release date  | Data sheet status     | Change notice | Supersedes  |
|----------------|---|-----------------------|---------------|-------------|
| 74LVC1G17_6    | 20070827  | Product data sheet    | -             | 74LVC1G17_5 |
| Modifications: | <ul style="list-style-type: none"> <li>In <a href="#">Section 10 “Static characteristics”</a>, changed conditions for input leakage and supply current.</li> <li><a href="#">Figure 16 “Package outline SOT891 (XSON6)”</a> updated.</li> </ul> |                       |               |             |
| 74LVC1G17_5    | 20061006  | Product data sheet    | -             | 74LVC1G17_4 |
| 74LVC1G17_4    | 20041130  | Product specification | -             | 74LVC1G17_3 |
| 74LVC1G17_3    | 20041018  | Product specification | -             | 74LVC1G17_2 |
| 74LVC1G17_2    | 20040407  | Product specification | -             | 74LVC1G17_1 |
| 74LVC1G17_1    | 20040324  | Product specification | -             | -           |

## 17. Legal information

### 17.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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